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Renesas Technology Corp. Customer Support Dept. April 1, 2003



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semiconductors may lead to personal injury, fire or property damage.
 Remember to give due consideration to safety when making your circuit designs, with appropriate
measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of nonflammable material or
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10-to-4-line Priority Encoder



ADE-205-446 (Z) 1st. Edition Sep. 2000

Description

The HD74HC147 features priority encoding of the inputs to ensure that only the highest order data line is encoded. Nine input lines are encoded to a four line BCD output. The implied decimal zero codition requires no input condition as zero is encoded when all nine data lines are at a high logic level. All data inputs and outputs are active at the low logic level.

Features

High Speed Operation: t_{pd} = 14.5 ns typ (C_L = 50 pF)
 High Output Current: Fanout of 10 LSTTL Loads

• Wide Operating Voltage: $V_{CC} = 2$ to 6 V

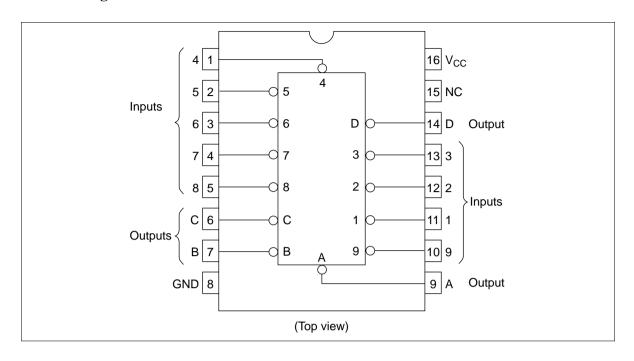
• Low Input Current: 1 μA max

• Low Quiescent Supply Current: I_{CC} (static) = 4 μ A max (Ta = 25°C)

Function Table

Inpu	Inputs										Outputs			
1	2	3	4	5	6	7	8	9	D	С	В	Α		
Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н		
X	Χ	Χ	Χ	Χ	Χ	Χ	Χ	L	L	Н	Н	L		
X	Х	Х	Х	Χ	Х	Х	L	Н	L	Н	Н	Н		
X	Χ	Χ	Χ	Χ	Χ	L	Н	Н	Н	L	L	L		
X	Χ	Χ	Χ	Χ	L	Н	Н	Н	Н	L	L	Н		
X	Χ	Χ	Χ	L	Н	Н	Н	Н	Н	L	Н	L		
Χ	Χ	Χ	L	Н	Н	Н	Н	Н	Н	L	Н	Н		
X	Χ	L	Н	Н	Н	Н	Н	Н	Н	Н	L	L		
Χ	L	Н	Н	Н	Н	Н	Н	Н	Н	Н	L	Н		
L	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	L	_	

Pin Arrangement



DC Characteristics

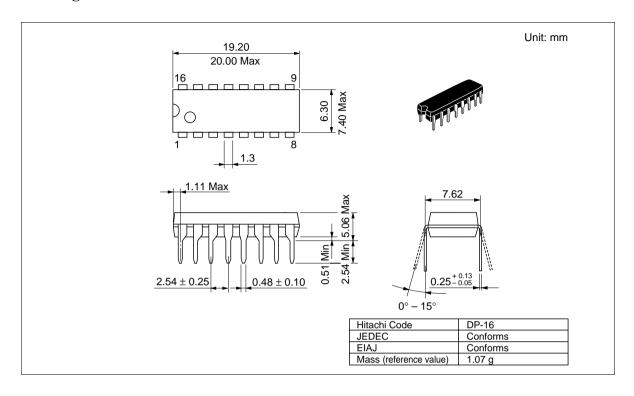
			Ta = 25°C		Ta = -40 to +85°C		_			
Item	Symbol	V _{cc} (V)	Min	Тур	Max	Min	Max	Unit	Test Condition	าร
Input voltage	V_{IH}	2.0	1.5	_		1.5	_	V		
		4.5	3.15	_		3.15	_	_		
		6.0	4.2	_	_	4.2	_	_		
	V _{IL}	2.0	_	_	0.5	_	0.5	V		
		4.5	_	_	1.35	_	1.35	_		
		6.0	_	_	1.8	_	1.8	=		
Output voltage	V _{OH}	2.0	1.9	2.0	_	1.9	_	V	Vin = V _{IH} or V _{IL}	$I_{OH} = -20 \mu A$
		4.5	4.4	4.5	_	4.4	_	=		
		6.0	5.9	6.0	_	5.9	_	=		
		4.5	4.18	_	_	4.13	_	=		$I_{OH} = -4 \text{ mA}$
		6.0	5.68	_	_	5.63	_	=		$I_{OH} = -5.2 \text{ mA}$
	V _{OL}	2.0	_	0.0	0.1	_	0.1	V	Vin = V _{IH} or V _{IL}	I _{OL} = 20 μA
		4.5	_	0.0	0.1	_	0.1	_		
		6.0	_	0.0	0.1	_	0.1	_		
		4.5	_	_	0.26	_	0.33	=		I _{OL} = 4 mA
		6.0	_	_	0.26	_	0.33	=		I _{OL} = 5.2 mA
Input current	lin	6.0	_	_	±0.1	_	±1.0	μΑ	Vin = V _{CC} or Gf	ND
Quiescent supply current	I _{cc}	6.0	_	_	4.0	_	40	μΑ	Vin = V _{CC} or Gi	ND, lout = $0 \mu A$

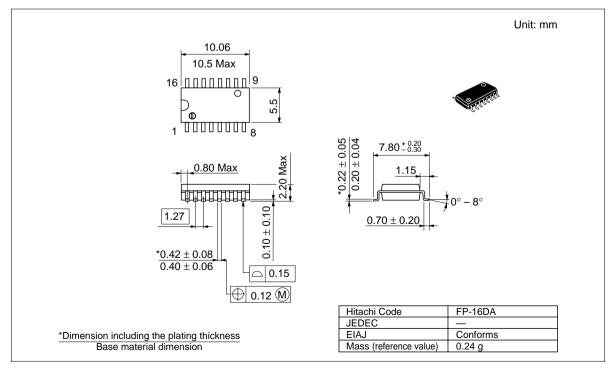
AC Characteristics ($C_L = 50 \text{ pF}$, Input $t_r = t_f = 6 \text{ ns}$)

Ta = -40 to $Ta = 25^{\circ}C$ +85°C

	Symbol								
Item		V _{cc} (V)	Min	Тур	Max	Min	Max	Unit	Test Conditions
Propagation delay	t _{PLH}	2.0	_	_	220	_	275	ns	
time		4.5	_	15	44	_	55		
		6.0	_	_	37	_	47	_	
	t _{PHL}	2.0	_	_	220	_	275	ns	
		4.5	_	14	44	_	55	_	
		6.0	_	_	37	_	47	_	
Output rise/fall	t _{TLH}	2.0	_	_	75	_	95	ns	
time	$t_{\scriptscriptstyle THL}$	4.5	_	5	15	_	19	_	
		6.0	_	_	13	_	16	=	
Input capacitance	Cin	_	_	5	10	_	10	pF	

Package Dimensions





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